

Improved Geometry

Transfers of Populated

Printed Wiring Boards

Between ECAD and

MCAD Systems

Robb McCord  
Cad/Cam Engineer  
Northrop Grumman

# GLOBAL PRODUCT DATA INTEROPERABILITY **S U M M I T** 2014



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2014  
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# Overview

- **Organization overview**
- **Designs of Printed Wiring Boards (PWB's) proceeds in parallel on separate Ecad and Mcad systems – Expedition and NX 7.5**
- **Geometry Checking is on-going during the design:**
  - Board outline
  - Component pin 1 location
  - Through and blind holes
  - Keepouts, other outlines and cutouts
  - Dxf or iges based using overlays
- **Vendor supplied IDF software (Epak) for Ecad <> Mcad transfers creates “dumb extrusions” (not exact)**

# ES Engineering Environment Development and Support

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- **Provide engineering tools, support and infrastructure across the sector to facilitate the “Design Anywhere” concept and associated return on investment.**
- **Develop, Maintain and Optimize the engineering tools and related infrastructure across the sector. Resulting in increased engineering mobility, efficiency, productivity and lower overall tool costs.**
- **Key Activities:**
  - **Maximize tool license utilization and ensure license compliance**
  - **Provide technical tool support to maximize efficiency, leverage reuse and increase proficiency**
  - **Technology Insertion to address program needs**
  - **Address application interoperability, version compatibility & data conversion**
- **Greg Hodges Director EEDS**

# ES Sector Primary Common Tools

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## Requirements Development & Analysis

- ARM
- DOORS
- Matlab
- Phoenix
- Integration
- CAIV
- Acelt
- PRICE
- SEER

## Product Design, Development & Analysis

### Hardware

- Agilent
- Ansoft
- Ansys
- Cadence
- CST
- Mentor
- MSC
- Parametric Technology
- Relex
- Synopsys
- Synplicity
- NX
- Zuken

### Software

- Artisan
- IBM Rational
- Oracle Enterprise Repository
- WindRiver
- Mercury

## Test & Integration

### Hardware

- MVP
- National Instruments

### Software

- ParaSoft
- Palamida
- Junit
- Coverity

## Manufacturing & Delivery

- SAP/MES
- SAP/MRP
- TeamCenter Mfg
- Valor
- VMetric

## Post Deployment Support

- GOLD
- SLICwave

This case study: Mentor Expedition V7 (Ecad) and Seimens NX V7.5 Managed by Teamcenter Unified (Mcad)

ISE, PDM, PaRTS, Goldfire, Specs & Standards

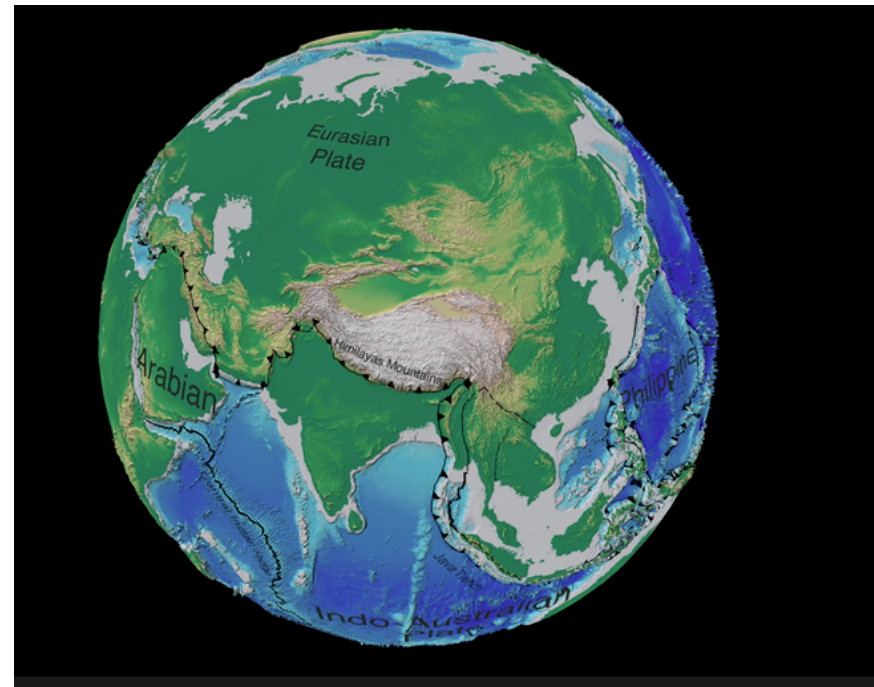
- **ES Sector Wide Tools - Fully Supported Engineering Tools - (Tier 1)**
  - NX, TcU, Mentor Expedition, ...
- **Multi-Campus Tools - Partially Supported Engineering Tools - (Tier 2) Legacy data/software, previous/interim standards**
  - Inventor, Cadence Allegro, ...
- **Specialty Tools- Site or Department Engineering Tools - (Tier 3) engineering tools that are specialty or niche (not EEDS supported)**

# Historic Ecad <> Mcad Disconnect

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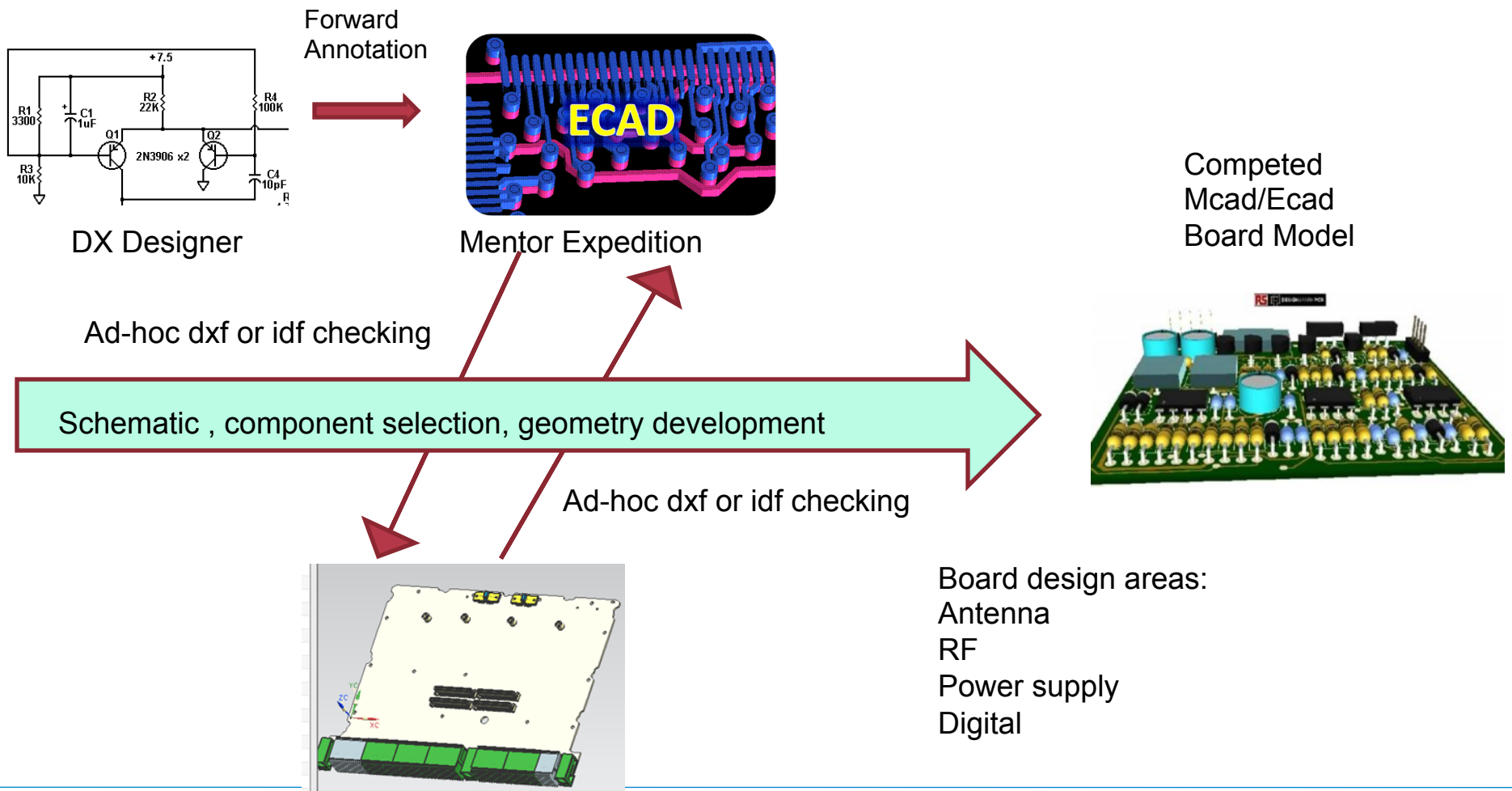
Ecad World View



Mcad World View

# Former Process for Mcad <> Ecad Interoperation

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# Definitions

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- ***Reference Designators***: alphanumeric designation for board components that need to be preserved through out any transfers
- ***Critically placed connectors***: interface with other parts of the mechanical design.
- ***Intermediate Data Format (IDF)***: early standard attempting to bridge the Ecad/Mcad chasm
- ***“Epak”***: bidirectional IDF translator from LTX Software – add on to NX
- ***Mentor Expedition Cell***: Library storage unit – multiple cells per p/n based on different board outlines



# Former Process for Mcad <> Ecad Interoperation

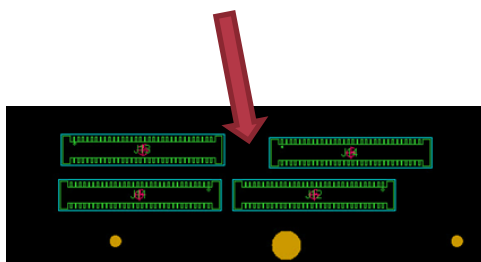
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- **In parallel**
  - **Ecad selects connectors to package and assigns reference designators for each component**
  - **Mcad creates board and other outlines with board origin with 1 unplated hole for 0,0**
- **A series of “ad-hoc” transfers of IDF and DXF are used to manually check the geometry as the design proceeds.**
- **Basically overlays of wireframe**
- **Corrections manually communicated**

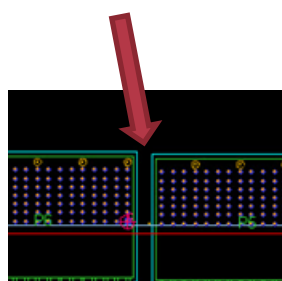
# Problems with Former Process

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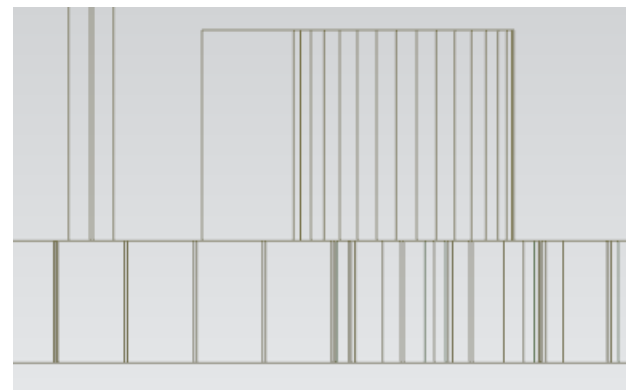
- Human errors associated with manual processes
- Tough to spot differences in the size range of the thickness of a line on the screen
- Reference designators were not preserved in dxf and these are required for any type of associativity between Ecad and Mcad systems.



Easy



Hard

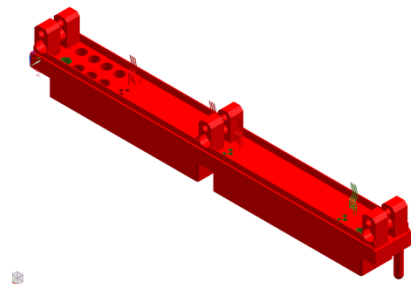


Impossible

# One to Many Problem

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- One 3D NX model for each critically placed library part (mostly connectors), example Amphenol p/n 10\_507820
- One Mentor Expedition library part for each *orientation* of that part, i.e., board top, bottom, side or x-y orientation



Mcad library  
part

10\_507820\_topy



10\_507820\_edge



10\_507820\_topx

Expedition library parts

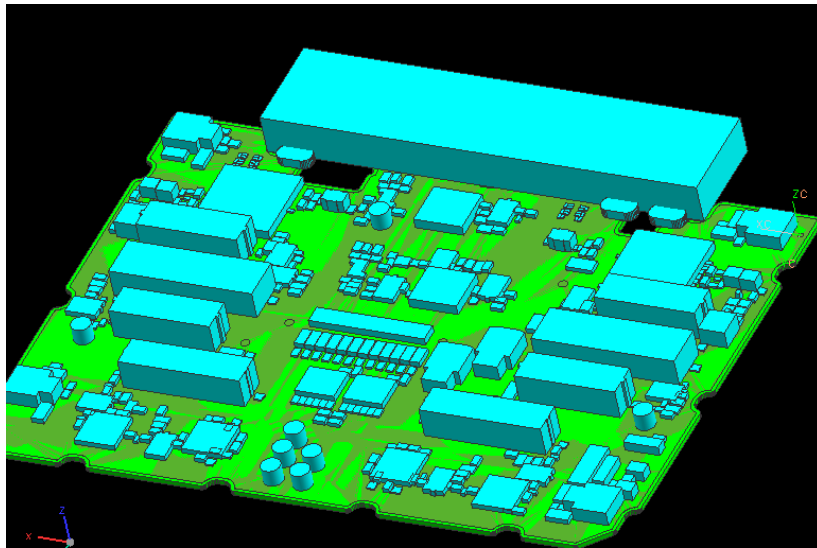
# The problem with IDF

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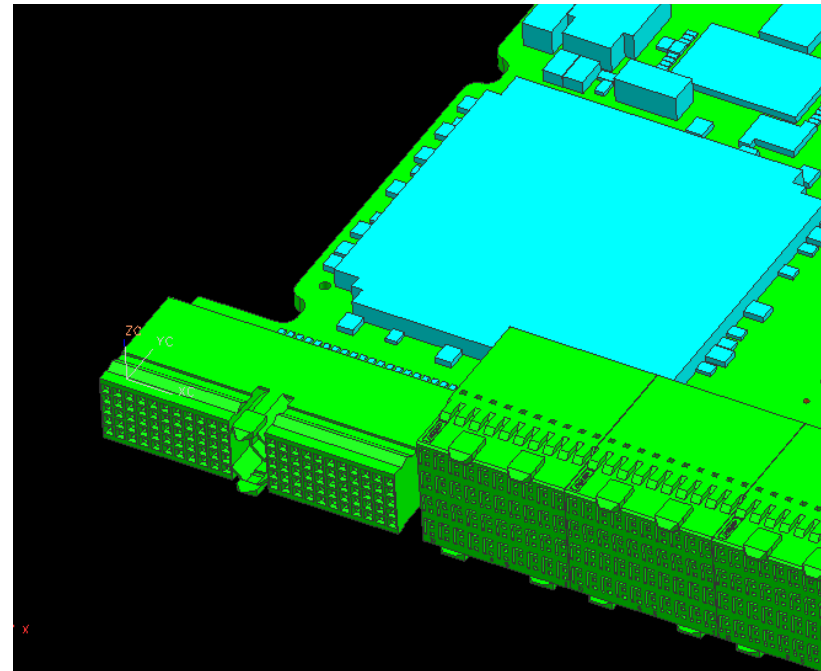
- **Reference designators are preserved (unlike dxf) – good.**
- **Out of the box Epak behavior is of 2 flavors:**
  - **Basic: builds 2d geometry on Mcad import and then extrudes the components in “dumb” solids based on the Z axis height of the Expedition library part. Ref Desk's are preserved. Round tripping is possible**
  - **Advanced: Will substitute in “real” library connectors on Mcad import but remember “one to many” - Which One? And What Orientation?**

# The problem with IDF

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Basic: Dumb Extruded Mcad Model based on Ecad library heights – inexact and dangerous



Advanced: Real Mcad assembly model with actual connector library parts – the Holy Grail

# Genesis of a Solution

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- **NX Reference Set:** Designates what geometry is to be displayed in a component at a higher assembly level.
- **NX Work Coordinate System (WCS):** stored information on orientation and location
- **Eureka Discovery:** NX has an undocumented ability to store a WCS in a Reference Set
- **What if....**

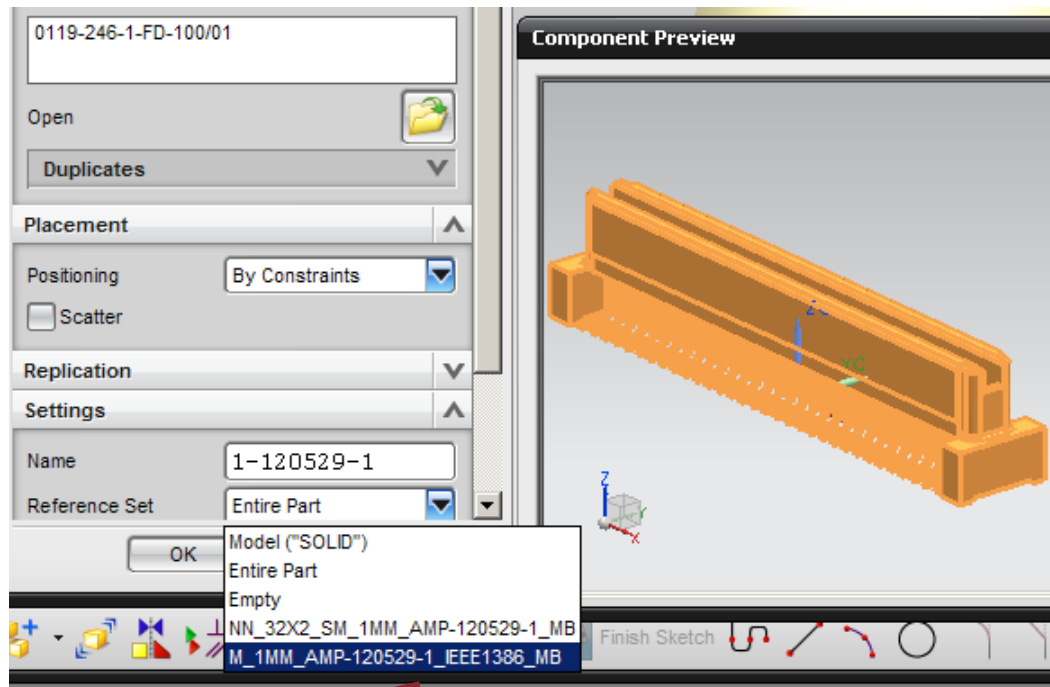
# ...What If?

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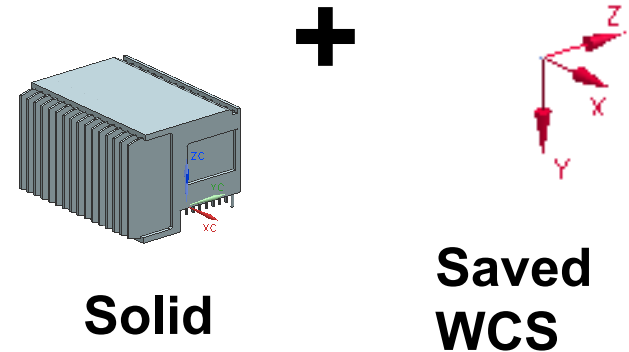
- Every Mcad connector library part had a *reference set* that contained geometry and a saved WCS that matched it to every occurrence of that connector in the Ecad library?
- The Epak software could map everything thus maintaining associativity in cell names and reference designators in bidirectional IDF transfers?
- As a preview, full credit for what follows goes to Keith Anderson and LTX Software for working with us and implementing all the required changes.

# Solution Essentials – Part 1 – Mcad Library Modification

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**Add Reference Sets**



**Mcad reference set names match Ecad cell names – one to one.**



# Solution Essentials – Part 1 – Mcad Library Modification

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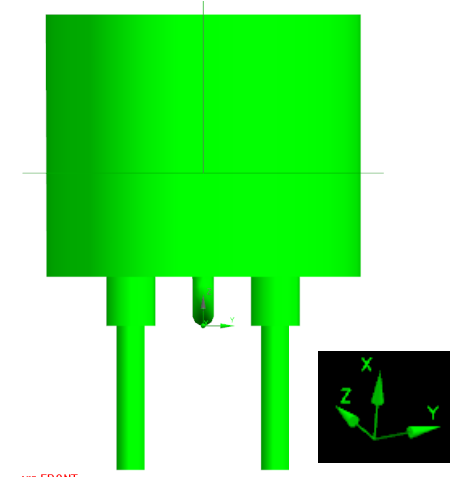
## MCAD

Solids plus saved coordinates system

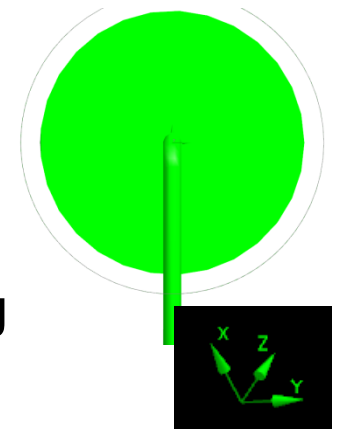
## ECAD

2D board footprint outline

**NX p/n 1-120529-1**      =      **Expedition cell**  
**Ref Set**  
**nn\_32x3\_1-1205290-1**      **nn\_32x3\_1-1205290-1**



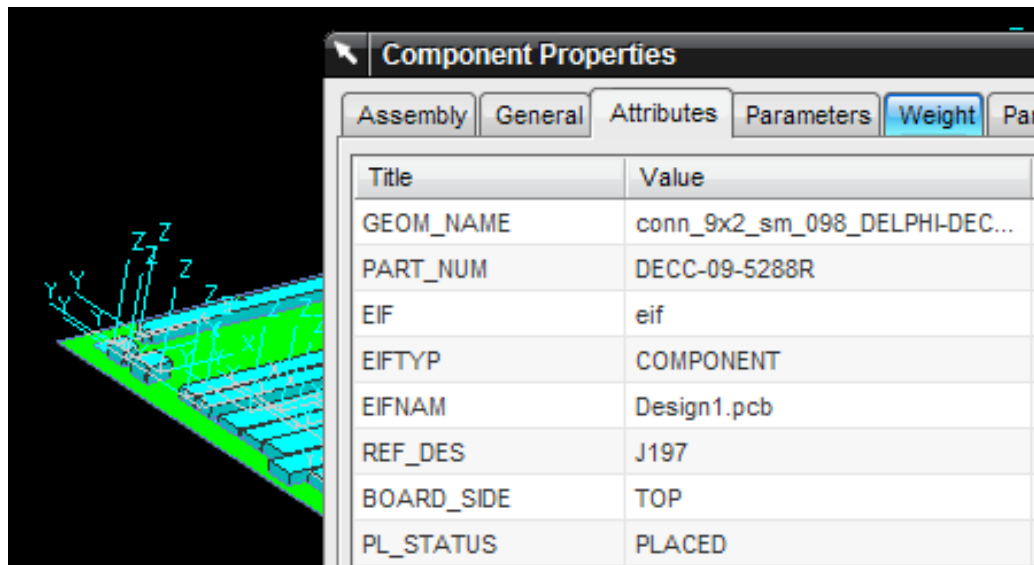
**NX p/n 1-120529-1**      =      **Expedition cell**  
**Ref Set**  
**m\_1mm\_1-1205290-1**      **m\_1mm\_1-1205290-1**



**Geometry plus orientation ... equals a one to one mapping  
between Mcad and Ecad**

# Solution Essentials – Part 2 Component Properties Created During IDF Import

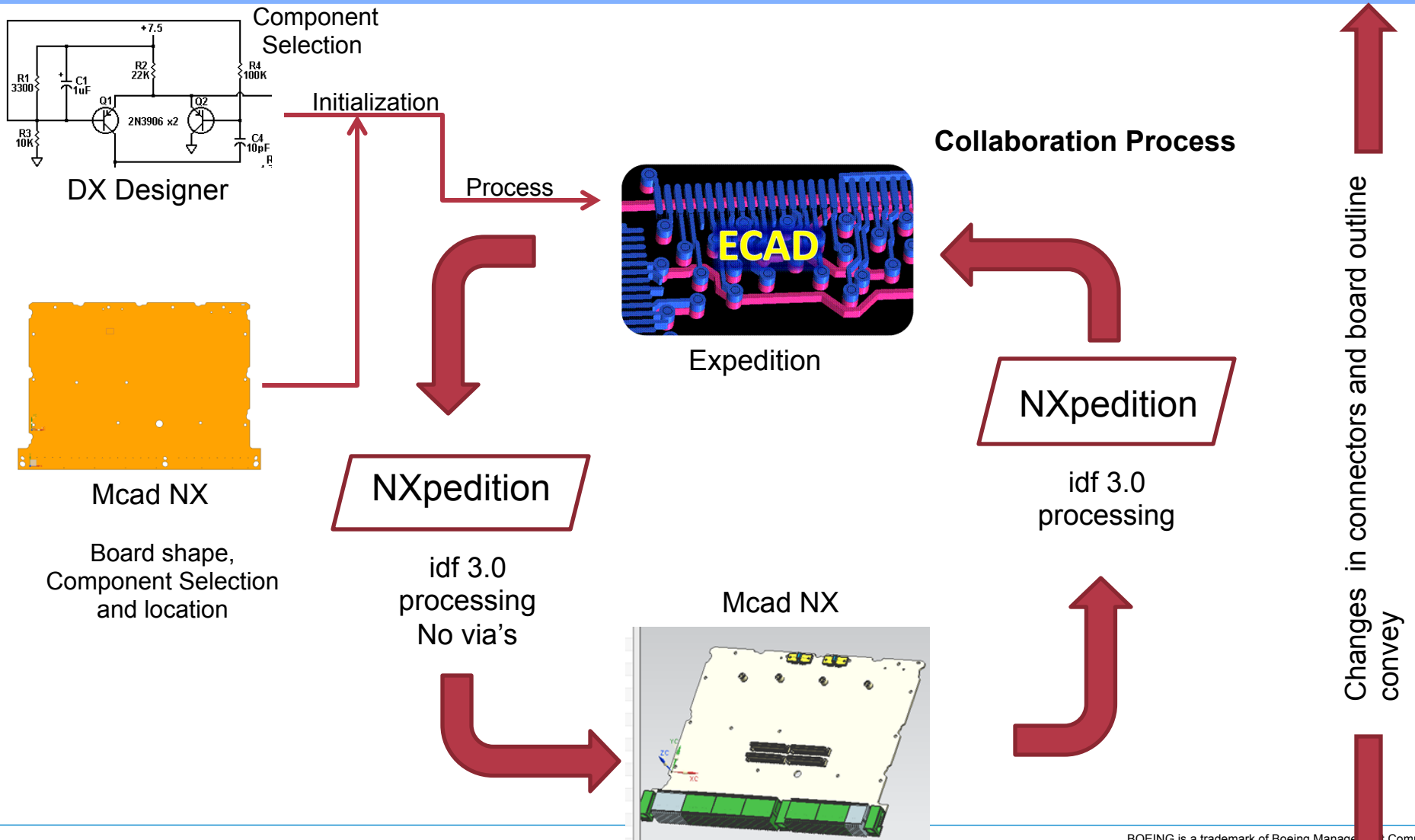
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- NX attributes created in NX board assembly file on first IDF import (initialization).
  - Mentor cell name, P/N, reference designator, board side etc.
- Preserved in future round trips to Expedition and back

# Solution Overview

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# Custom IDF Processing - NXpedition

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- **In house developed visual basic to post-process IDF files from Mentor Expedition and Siemens NX**
- **Expedition to NX**
  - Rename IDF and library files from emn and emp to brd and lib
  - Remove routing via's (not required on Mcad and makes files too large to process sometimes)
  - Syntax validation and geometry checking.
- **NX to Expedition**
  - Rename IDF and library files from brd and lib to emn and emp
  - Remove spaces in layers, syntax validation and geometry checking.
- **Future customizations**



# Solution Details

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- **Uses Epak IDF in component substitution mode**
- **Saved NX reference sets represent each Expedition cell to solve the one to many problem**
- **After initialization, data can be round tripped as many times as necessary with preservation of : p/n's, board geometry, reference designators, cell names, origins and orientations.**
- **Incoming IDF automatically syncs geometry on the receiving system**
- **Eliminates most of the tedious human checking looking for changes**

# Usage Scenario: Initialization process builds Mcad assembly with library components based on incoming IDF

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Assembly Navigator

Number	Revisi...	Name	Description	ref_des
Sections				
<input checked="" type="checkbox"/> IDF_TEST_SEK	01	idf_test_sek	IDF_TEST_SEK	
<input checked="" type="checkbox"/> 1410187-3	01	CONNECTOR, PLUG, RT ANGLE, 7 ROW X...	MultiGig RT2 daughter 3-row 16-column	P5
<input checked="" type="checkbox"/> 1410187-3	01	CONNECTOR, PLUG, RT ANGLE, 7 ROW X...	MultiGig RT2 daughter 3-row 16-column	P4
<input checked="" type="checkbox"/> 1410187-3	01	CONNECTOR, PLUG, RT ANGLE, 7 ROW X...	MultiGig RT2 daughter 3-row 16-column	P3
<input checked="" type="checkbox"/> 1410187-3	01	CONNECTOR, PLUG, RT ANGLE, 7 ROW X...	MultiGig RT2 daughter 3-row 16-column	P2
<input checked="" type="checkbox"/> 1410187-3	01	CONNECTOR, PLUG, RT ANGLE, 7 ROW X...	MultiGig RT2 daughter 3-row 16-column	P1
<input checked="" type="checkbox"/> 1410189-3	01	1410189-3	1410189-3	P0
<input checked="" type="checkbox"/> 0119-246-1-FD-100	01	CONNECTOR, GPO, FULL DETENT, MALE ...	I:\ug1\templates\connectors\smountgpo...	J20
<input checked="" type="checkbox"/> 0119-246-1-FD-100	01	CONNECTOR, GPO, FULL DETENT, MALE ...	I:\ug1\templates\connectors\smountgpo...	J21
<input checked="" type="checkbox"/> 0119-246-1-FD-100	01	CONNECTOR, GPO, FULL DETENT, MALE ...	I:\ug1\templates\connectors\smountgpo...	J22
<input checked="" type="checkbox"/> 0119-246-1-FD-100	01	CONNECTOR, GPO, FULL DETENT, MALE ...	I:\ug1\templates\connectors\smountgpo...	J23
<input checked="" type="checkbox"/> 1-1469492-9	01	CONNECTOR ACCESSORY, GUIDE, MODU...	1-1469492-9	J3
<input checked="" type="checkbox"/> 1-1469492-9	01	CONNECTOR ACCESSORY, GUIDE, MODU...	1-1469492-9	J2
<input checked="" type="checkbox"/> 1-1469492-9	01	CONNECTOR ACCESSORY, GUIDE, MODU...	1-1469492-9	J1
<input checked="" type="checkbox"/> A17860-001	01	CONNECTOR, 10 PIN, MALE, HORIZONTAL...	Connector, 10 pin w/mtg latch	J101
<input checked="" type="checkbox"/> A17860-001	01	CONNECTOR, 10 PIN, MALE, HORIZONTAL...	Connector, 10 pin w/mtg latch	J102
<input checked="" type="checkbox"/> 1410190-3	01	1410190-3	1410190-3	P6
<input checked="" type="checkbox"/> 1-120529-1	01	CONNECTOR, RECEPTACLE, BOARD STA...	120529_1	J13
<input checked="" type="checkbox"/> 1-120529-1	01	CONNECTOR, RECEPTACLE, BOARD STA...	120529_1	J11
<input checked="" type="checkbox"/> 1-120529-1	01	CONNECTOR, RECEPTACLE, BOARD STA...	120529_1	J14
<input checked="" type="checkbox"/> 1-120529-1	01	CONNECTOR, RECEPTACLE, BOARD STA...	120529_1	J12

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Descriptive Part Name	Reference Set
Sections	
idf_test_sek-01	
1410187-3-01	X7_1.8X1.35MM_TYCO-1410190-3_A
1410187-3-01	X7_1.8X1.35MM_TYCO-1410190-3_A
1410187-3-01	X7_1.8X1.35MM_TYCO-1410190-3_A
1410187-3-01	X7_1.8X1.35MM_TYCO-1410190-3_A
1410187-3-01	X7_1.8X1.35MM_TYCO-1410190-3_A
1410189-3-01	X7_1.8X1.35MM_TYCO-1410189-3_A
0119-246-1-fd-100-01	CONN_GPO_GILBERT-0119-246-1_A
0119-246-1-fd-100-01	CONN_GPO_GILBERT-0119-246-1_A
0119-246-1-fd-100-01	CONN_GPO_GILBERT-0119-246-1_A
0119-246-1-fd-100-01	CONN_GPO_GILBERT-0119-246-1_A
1-1469492-9-01	CONN_2_SM_TYCO-1-1469492-X_A
1-1469492-9-01	CONN_2_SM_TYCO-1-1469492-X_A
1-1469492-9-01	CONN_2_SM_TYCO-1-1469492-X_A
a17860-001-01	0_SM_50_OMNETICS-A17860-001_MB
a17860-001-01	0_SM_50_OMNETICS-A17860-001_MB
1410190-3-01	X7_1.8X1.35MM_TYCO-1410190-3_A
1-120529-1-01	NN_32X2_SM_1MM_AMP-120529-1_MB
1-120529-1-01	M_1MM_AMP-120529-1_IEEE1386_MB
1-120529-1-01	NN_32X2_SM_1MM_AMP-120529-1_MB
1-120529-1-01	M_1MM_AMP-120529-1_IEEE1386_MB

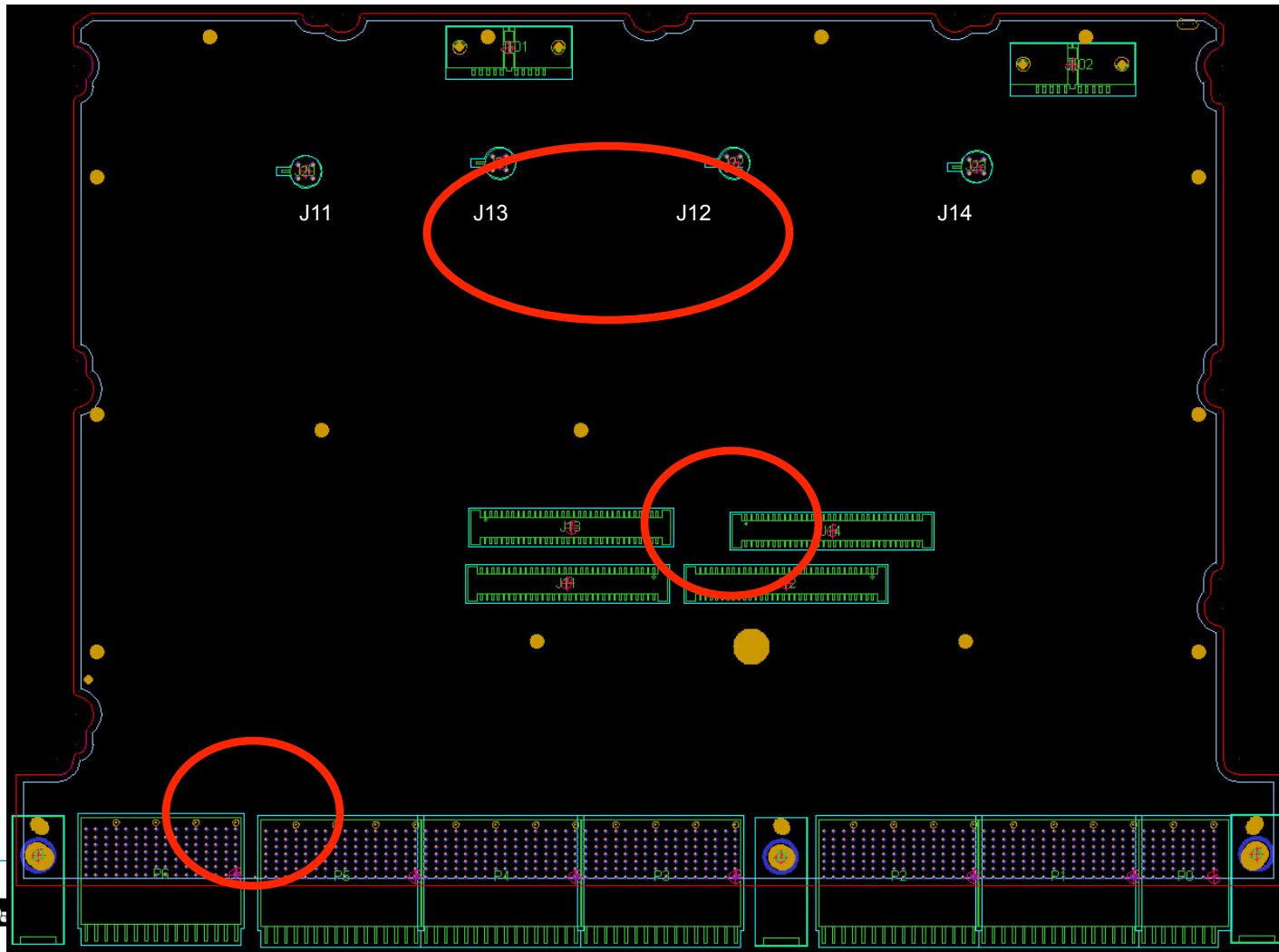
Single P/N with 2 reference sets (ie there are 2 ECAD cells for this p/n.

NX Reference Set Name = Expedition Cell Name

P/N's common to ECAD and MCAD

# Usage Scenario: But some components are misplaced and Reference Designators incorrect

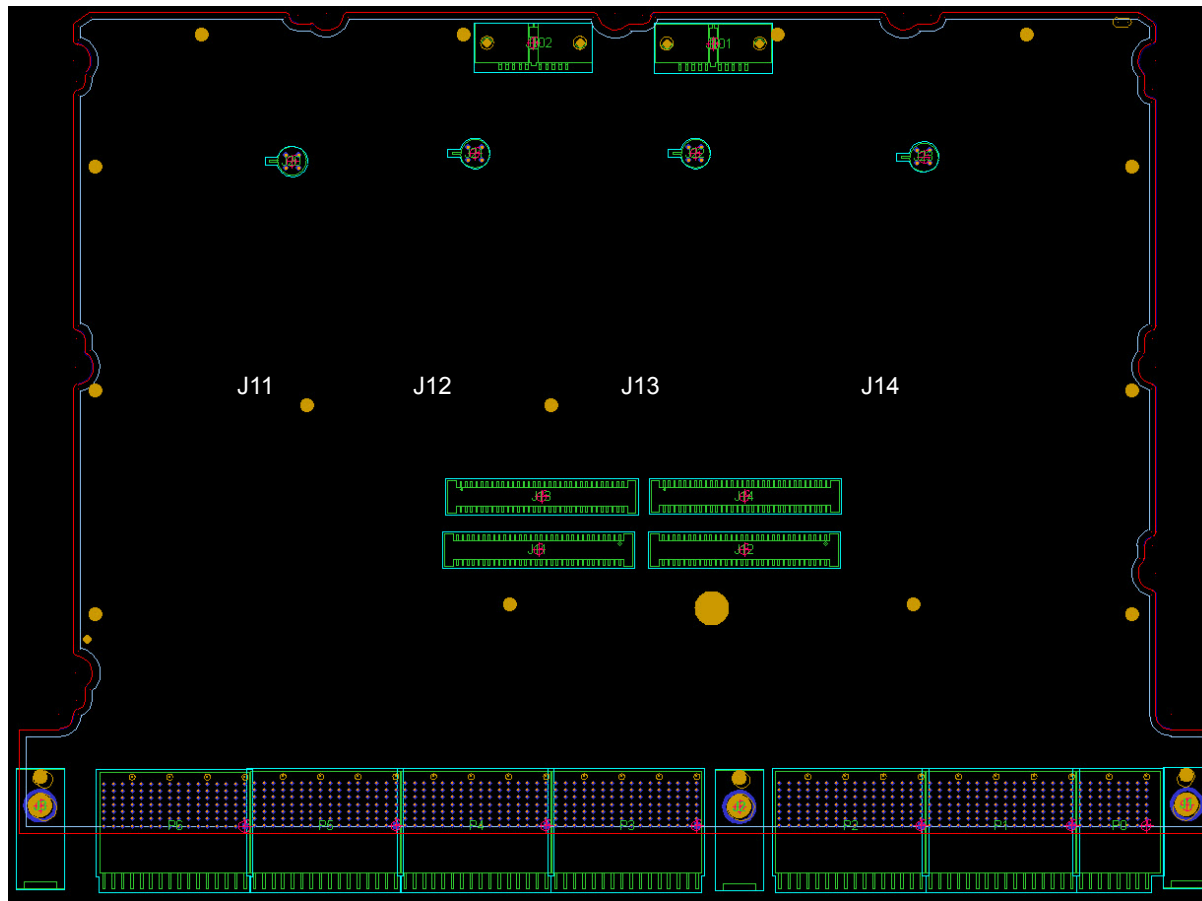
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# Usage scenario: Mcad corrects model and roundtrips IDF back to Expedition where changes automatically made

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# Issues

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- **Some types of holes get double geometry sometimes**
- **Developing a list of connectors that will be used moving forward (i.e. not everyone ever used)**
- **“special” geometry only used at NGES**
- **NX7.5 – 30 character limit in reference set name**
- **Convincing Ecad that they won’t fall off the edge of their world! (i.e. cultural resistance to process change)**
- **Undocumented WCS reference set capability in NX may go away**
- **Part families**

# Future

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- **Work with LTX to develop “no move” option for when design is complete and no “auto move” is desired**
- **Develop capabilities for other types of components such as chips, caps and resistors.**
- **Cleanup of legacy names in Mcad and Ecad libraries so there is a strict “one to one” correlation**
- **Complete modifying NX library connectors with Expedition library info.**
- **Complete Rollout in NX 8.5 – 3rd quarter 2014**

# Conclusion

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- **Solution developed that solves the basic “one to many” disconnect and allows full Mcad / Ecad interoperation**
- **Automatic geometry error checking – locations and shape are locked in synch between the two systems.**
- **Anybody using NX and the current version of LTX Epak IDF software can utilize**
  - **IDF to Mcad – matching p/n and reference set**
  - **IDF to Ecad – matching p/n and cell name**
- **Greatly reduces errors and costly rework .**

# Thank You

Questions?

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